

Call for Paper

ICEDME 2018

2018 International
Conference on Electron
Device and Mechanical
Engineering

Website: www.icedme.net

Submission Deadline: **March 15, 2018**

Conference Date: March 23-25, 2018

Venue: Wuhan, China



ICEDME 2018 is a yearly International conference which the experts of this kind of field from different areas and countries will be invited to give the relevant speech. ICEDME 2018 is to provide a platform for researchers, professionals and other experts from around the world to present their research results in Electron Device and Mechanical Engineering.

ICEDME 2018 provides the experts with a valued opportunity to communicate with each other covering its large team, dependable committee and a large of sponsors from all over the world. A lot of participants from many kinds of fields will join in this grand international conference.

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Publication

IOP Conference Series
Proceedings services for science

All accepted full papers will be published by ***IOP Conference Series: Materials Science and Engineering (MSE)(ISSN: 1757-8981)*** and will be submitted to **El Compendex, Scopus and CPCI** for indexing.

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Topics

(I) Electron Device

Electronic and Embedded Systems

Modern Circuit Theory and Applications

(II) Mechanical Engineering

Acoustics

Acoustic Engineering

More Info: www.icedme.net/cfp

Submission

1. **AEIC SUBMISSION SYSTEM** : [Click](#)
2. **E-mail Submission**: Your paper and Paper Submission Form to icedme@126.com
3. **Download Manuscript Template**: [IOP Template](#)

Notes:

1. *Papers submitted to the conference should be in English.*
2. *Both Abstract and Full Paper are welcomed. The author can make an oral presentation after the Abstract is accepted and the payment is finished.*
3. *All submitted articles should report original, previously unpublished research results, experimental or theoretical. Articles submitted to the conference should meet these criteria and must not be under consideration for publication elsewhere. We firmly believe that ethical conduct is the most essential virtual of any academic. Hence any act of plagiarism is a totally unacceptable academic misconduct and cannot be tolerated.*

Regisrtation

Items	Registration fee (By US Dollar)
Regular Registration(4-6 pages)	450 USD/per paper
Additional Paper(4-6 pages)	430 USD/ per paper
Extra Pages (Begin at Page 7)	50 USD/ per extra page
Attendees without Papers	180 USD / per person
Attendees without Papers (Groups)	150 USD / per person (≥ 3 persons)
Purchase Extra Journal	75 USD/book

Schedule		
March. 23	11:00-17:00	Registration
March. 24	09:00-12:00	Speeches of Keynote Speakers
	12:00-14:00	Lunch
	14:00-17:30	Oral Presentations
	18:00-19:30	Banquet
March. 25	09:00-18:00	Academic Investigation

Oral Presentation Instruction

1. Timing: a maximum of 15 minutes total, including speaking time and discussion. Please make sure your presentation is well timed. Please keep in mind that the program is full and that the speaker after you would like their allocated time available to them.
2. You can use CD or USB flash drive (memory stick), make sure you scanned viruses in your own computer. Each speaker is required to meet her/his session chair in the corresponding session rooms 10 minutes before the session starts and copy the slide file(PPT or PDF) to the computer.
3. It is suggested that you email a copy of your presentation to your personal inbox as a backup. If for some reason the files can't be accessed from your flash drive, you will be able to download them to the computer from your email.

Poster Presentation Instruction

1. Maximum poster size is 59.4 CM wide by 84.1 CM high (A1) .
2. Posters are required to be condensed and attractive. The characters should be large enough so that they are visible from 1 meter apart.
3. Please note that during your poster session, the author should stay by your poster paper to explain and discuss your paper with visiting delegates.

Technical Program Committee

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Device and Mechanical Engineering

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